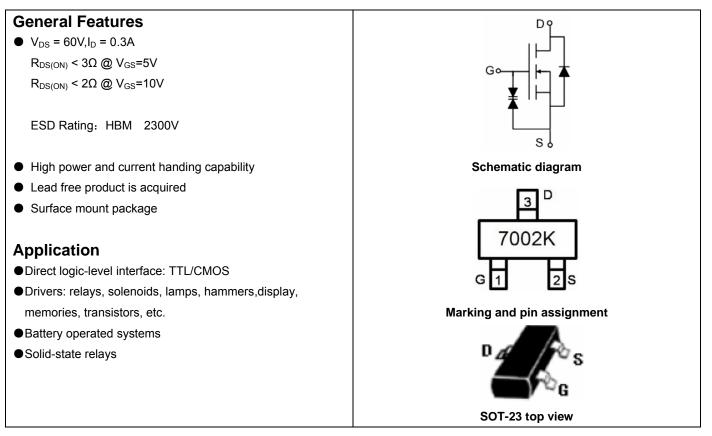




# NCE N-Channel Enhancement Mode Power MOSFET



## Package Marking And Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
7002K	2N7002K	SOT-23	Ø180mm	8 mm	3000 units

### Absolute Maximum Ratings (T<sub>A</sub>=25<sup>°</sup>C unless otherwise noted)

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage		Vds	60	V	
Gate-Source Voltage	Vgs	±20	V		
	T <sub>A</sub> =25℃	1	0.3	٨	
Continuous Drain Current (TJ =150℃)	T <sub>A</sub> =100℃	- I <sub>D</sub>	0.19	A	
Drain Current-Pulsed (Note 1)	I <sub>DM</sub>	0.8	А		
Maximum Power Dissipation		PD	0.35	W	
Operating Junction and Storage Temperature Range		T <sub>J</sub> ,T <sub>STG</sub>	-55 To 150	°C	

### **Thermal Characteristic**

Thermal Resistance, Junction-to-Ambient (Note 2)	R <sub>θJA</sub>	350	°C <b>/W</b>	
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# Electrical Characteristics (T\_A=25 $^\circ\!\!\mathrm{C}$ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250µA	60	68	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS}$ =60V, $V_{GS}$ =0V	-	-	1	μA
Cata Rady Laakaga Current		$V_{GS}$ =±10V, $V_{DS}$ =0V	-	±100	±500	nA
Gate-Body Leakage Current	I <sub>GSS</sub>	$V_{GS}$ =±20V, $V_{DS}$ =0V	_	±4	±10	uA
On Characteristics (Note 3)						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS}$ , $I_{D}=250\mu A$	0.7	1.2	1.9	V
Drain-Source On-State Resistance		$V_{GS}$ =5V, I <sub>D</sub> =0.4A	-	1.3	3	Ω
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A	-	1	2	Ω
Forward Transconductance	<b>g</b> fs	V <sub>DS</sub> =10V,I <sub>D</sub> =0.2A	0.1	-	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C <sub>lss</sub>	V <sub>DS</sub> =25V,V <sub>GS</sub> =0V, F=1.0MHz	-	21	50	PF
Output Capacitance	C <sub>oss</sub>		-	11	25	PF
Reverse Transfer Capacitance	C <sub>rss</sub>		-	4.2	5	PF
Switching Characteristics (Note 4)	· · ·			•		
Turn-on Delay Time	t <sub>d(on)</sub>		-	10	-	nS
Turn-on Rise Time	tr	V <sub>DD</sub> =30V,I <sub>D</sub> =0.2A	-	50	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10V, $R_{GEN}$ =10 $\Omega$	-	17	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	10	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =10V,I <sub>D</sub> =0.3A, V <sub>GS</sub> =4.5V	-	1.7	3	nC
Drain-Source Diode Characteristics			•		•	
Diode Forward Voltage (Note 3)	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>S</sub> =0.2A	-	-	1.2	V
Diode Forward Current (Note 2)	Is		-	-	0.3	Α

#### Notes:

1. Repetitive Rating: Pulse width limited by maximum junction temperature.

2. Surface Mounted on FR4 Board, t ≤ 10 sec.

**3.** Pulse Test: Pulse Width  $\leq$  300µs, Duty Cycle  $\leq$  2%.

4. Guaranteed by design, not subject to production







# **Typical Electrical And Thermal Characteristics**

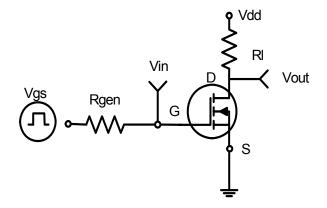
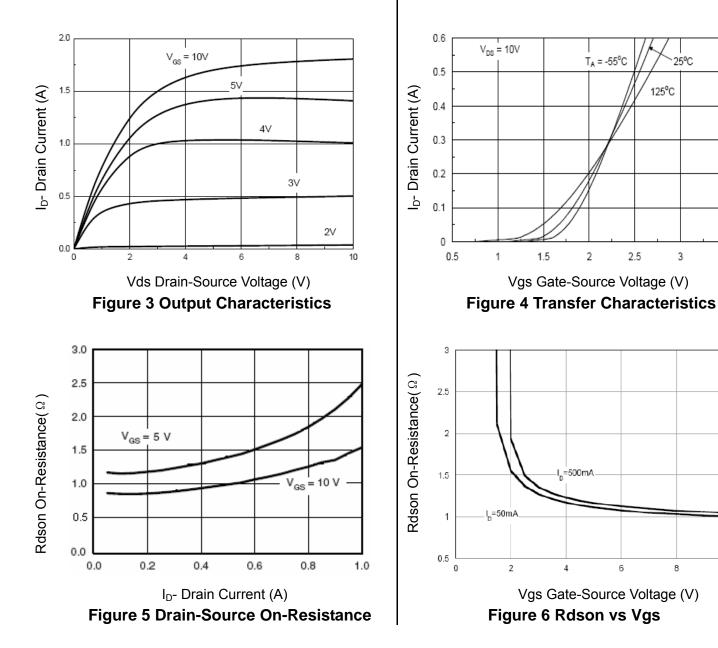
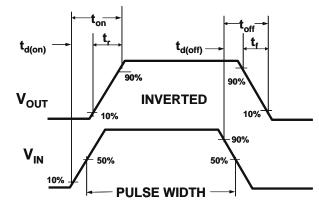


Figure 1:Switching Test Circuit







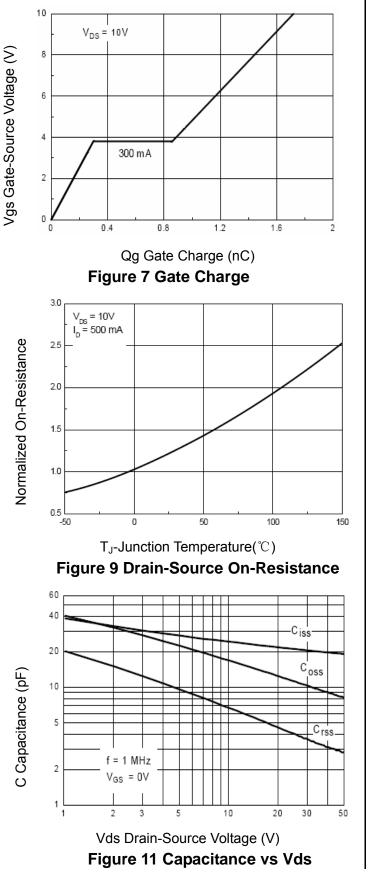
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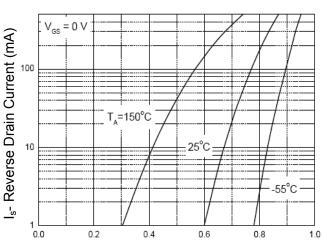
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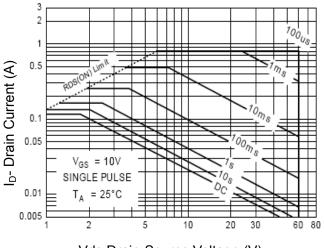


2N7002K





Vsd Source-Drain Voltage (V) Figure 8 Source-DrainDiode Forward



Vds Drain-Source Voltage (V) Figure 10 Safe Operation Area







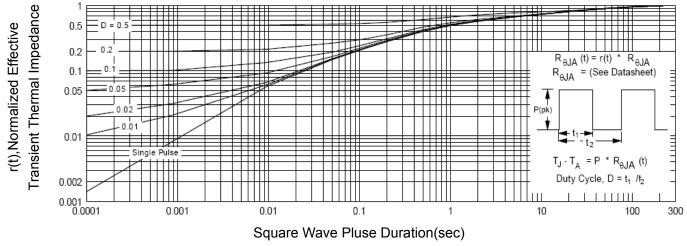
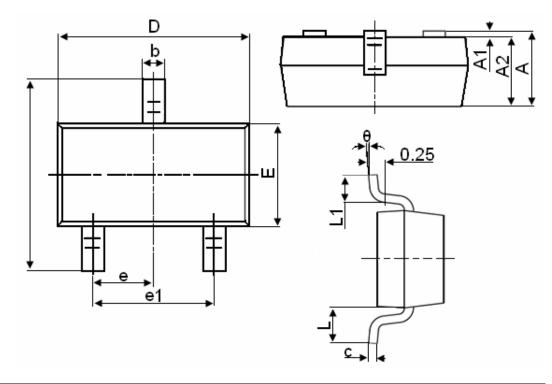


Figure 12 Normalized Maximum Transient Thermal Impedance





# **SOT-23 Package Information**



Symbol	Dimensions in Millimeters			
Symbol	MIN.	MAX.		
A	0.900	1.150		
A1	0.000	0.100		
A2	0.900	1.050		
b	0.300	0.500		
с	0.080	0.150		
D	2.800	3.000		
E	1.200	1.400		
E1	2.250	2.550		
е		0.950TYP		
e1	1.800	2.000		
L	0.550REF			
L1	0.300	0.500		
θ	0°	8°		

#### Notes

1. All dimensions are in millimeters.

2. Tolerance  $\pm 0.10$ mm (4 mil) unless otherwise specified

3. Package body sizes exclude mold flash and gate burrs. Mold flash at the non-lead sides should be less than 5 mils.

4. Dimension L is measured in gauge plane.

5. Controlling dimension is millimeter, converted inch dimensions are not necessarily exact.







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